

CGA4J2X8R1E334M125AE



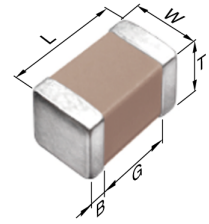
TDK item description CGA4J2X8R1E334MT***S

Applications Automotive Grade

Feature High Temperature Application
 Soft Termination
 AEC-Q200

Series CGA4(2012) [EIA 0805]

Status Production



Dimensions in mm

Size	
Length(L)	2.00mm +0.45,-0.20mm
Width(W)	1.25mm +0.25,-0.20mm
Thickness(T)	1.25mm +0.25,-0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering) 0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering) 0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering) 0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics	
Capacitance	330nF ±20%
Rated Voltage	25VDC
Temperature Characteristic	X8R(±15%)
Dissipation Factor (Max.)	3%
Insulation Resistance (Min.)	1515MΩ

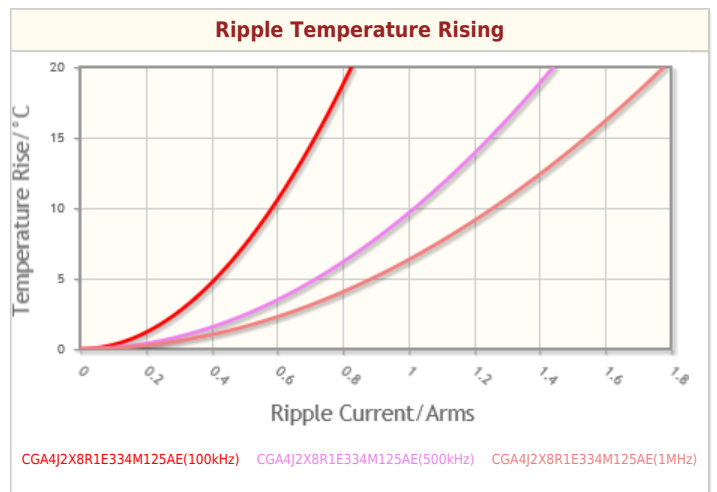
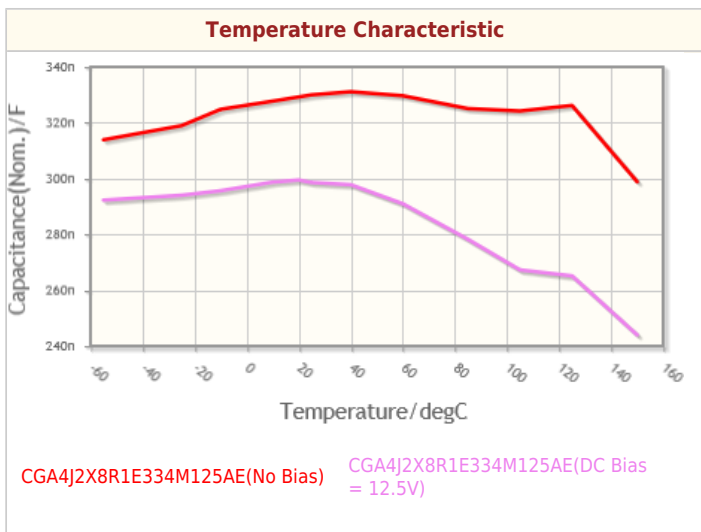
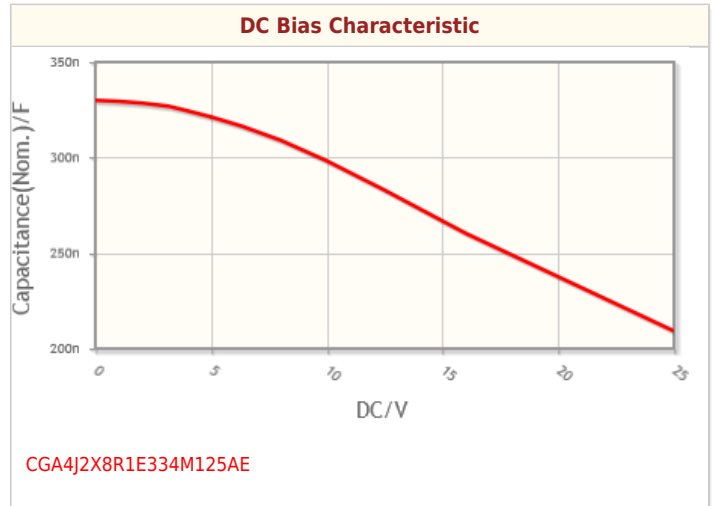
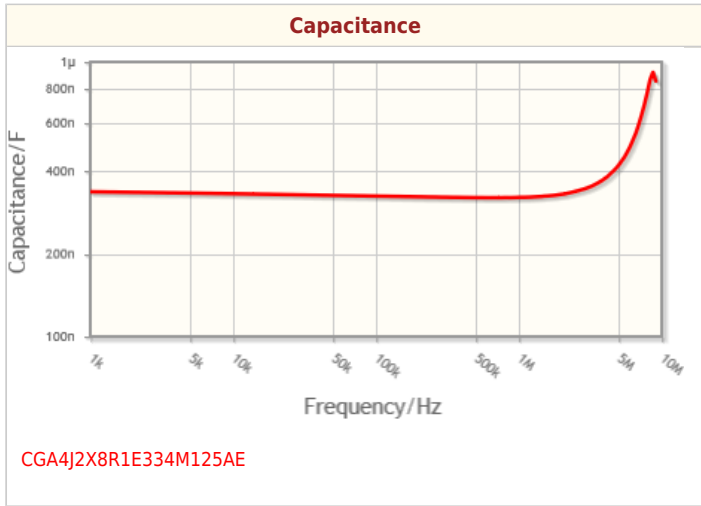
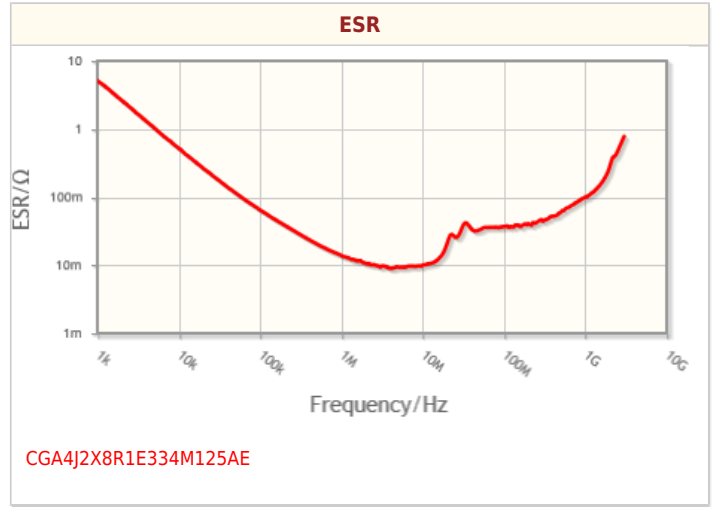
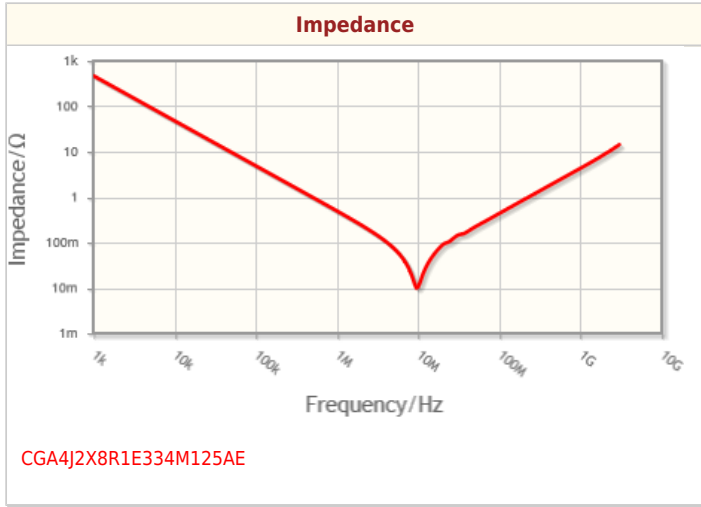
Other	
Soldering Method	Wave (Flow) Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

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 ! All specifications are subject to change without notice.

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Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



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Associated Images

